PATENT

TATES PATENT AND TRADEMARK OFFICE IN THE

In re Application of:

Kinsman et al.

Serial No.: 09/538,684

Filed: March 30, 2000

For: VARIED-THICKNESS HEAT SINK FOR INTEGRATED CIRCUIT (IC)

PACKAGES AND METHOD OF **FABRICATING IC PACKAGES**

Examiner: D. Graybill

Group Art Unit: 2814

Attorney Docket No.: 3056.1US (96-803.1)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Comparisoner for Patents, Washington, D.C. 20231.

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Samuel E. Webb
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ASSOCIATE POWER OF ATTORNEY (37 C.F.R. § 1.34(b))

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Sir:

In accordance with 37 C.F.R. § 1.34(b), please recognize the following individual as an associate agent/attorney herein in connection with the above-identified patent application:

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